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February 2008



FAIRCHILD SEMICONDUCTOR®

FGL40N120AND 1200V NPT IGBT

Features

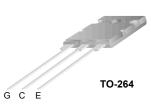
- High speed switching
- Low saturation voltage : $V_{CE(sat)}$ = 2.6 V @ I_C = 40A
- High input impedance
- CO-PAK, IGBT with FRD : t_{rr} = 75ns (typ.)

Applications

Induction Heating, UPS, AC & DC motor controls and general purpose inverters.

Description

Employing NPT technology, Fairchild's AND series of IGBTs provides low conduction and switching losses. The AND series offers an solution for application such as induction heating (IH), motor control, general purpose inverters and uninterruptible power supplies (UPS).





Absolute Maximum Ratings

Symbol	Parameter		FGL40N120AND	Units
V _{CES}	Collector-Emitter Voltage		1200	V
V _{GES}	Gate-Emitter Voltage		±25	V
	Collector Current	@T _C = 25°C	64	А
I _C	Collector Current	@T _C = 100°C	40	А
I _{CM(1)}	Pulsed Collector Current		160	А
I _F	Diode Continuous Forward Current	@T _C = 100°C	40	А
I _{FM}	Diode Maximum Forward Current		240	А
П	Maximum Power Dissipation	@T _C = 25°C	500	W
P _D	Maximum Power Dissipation	@T _C = 100°C	200	W
SCWT	Short Circuit Withstand Time, $V_{CE} = 600V, V_{GE} = 15V, T_{C} = 125^{\circ}C$		10	μs
TJ	Operating Junction Temperature		-55 to +150	۵°
T _{STG}	Storage Temperature Range		-55 to +150	°C
Τ _L	Maximum Lead Temp. for Soldering Purposes, 1/8" from Case for 5 second	ds	300	°C

Notes:

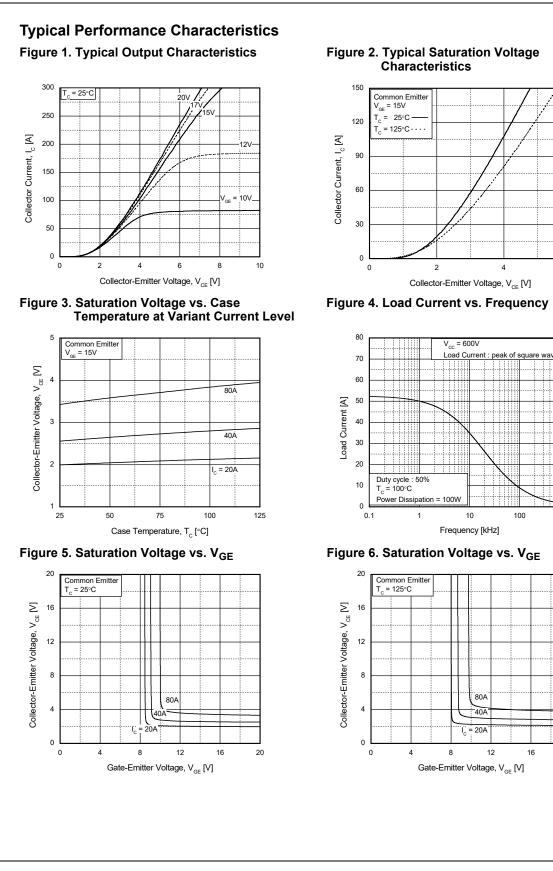
(1) Pulse width limited by max. junction temperature

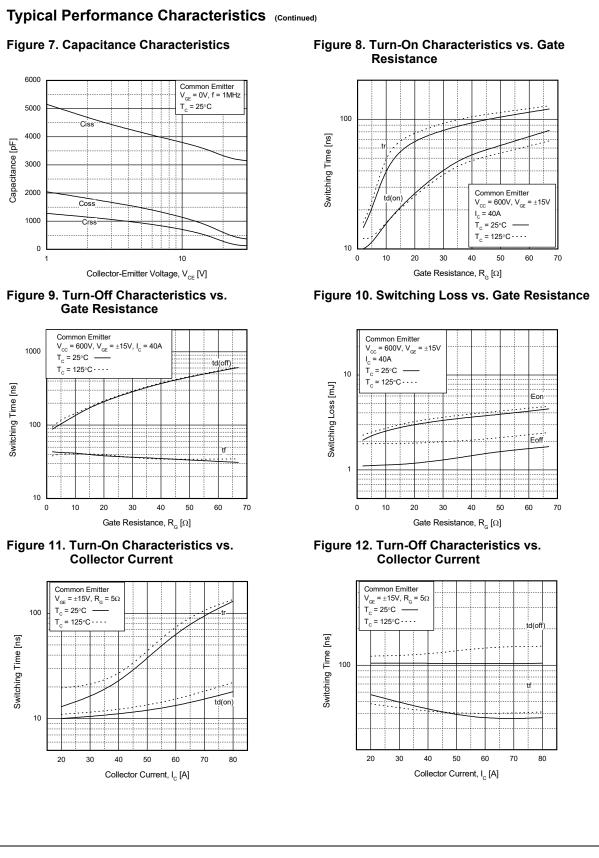
Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Units
$R_{\theta JC}(IGBT)$	Thermal Resistance, Junction-to-Case		0.25	°C/W
$R_{\theta JC}(DIODE)$	Thermal Resistance, Junction-to-Case		0.7	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction-to-Ambient		25	°C/W

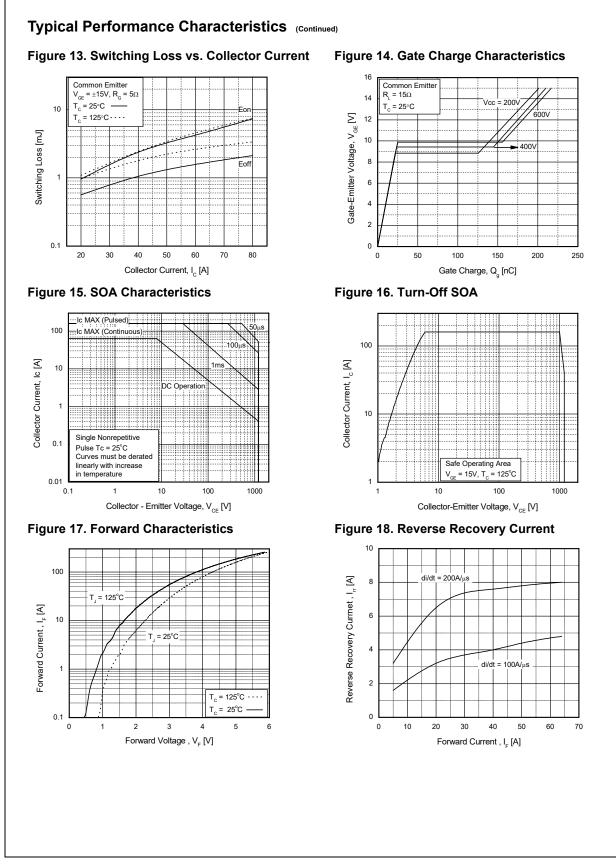
•		Pack	ckageReel SizeD-264-		Tape Width		Quantity 25		
		TO-2							
Electrica	al Cha	racteristics of	the IG	BT _{Tc} =	25°C unless otherwise not	ed			
Symbol		Parameter		Co	onditions	Min.	Тур.	Max.	Units
0							11		
Off Charact		r Emittor Proakdown V	(oltago	-01/	$1 - 1m\Lambda$	1200			V
BV _{CES}	Collector-Emitter Breakdown Voltage Temperature Coefficient of Breakdown Voltage		akdawn	V_{GE} = 0V, I _C = 1mA V_{GE} = 0V, I _C = 1mA		1200			v
BV _{CES} / ∆T _J			akuowii				0.6		V/°C
I _{CES}	Collector Cut-Off Current		,	$V_{CE} = V_{CES}, V_{GE} = 0V$				1	mA
I _{GES}	G-E Lea	kage Current	,	$V_{GE} = V_{GES}, V_{CE} = 0V$				±250	nA
On Characte	r	1 11.7 16							
V _{GE(th)}	G-E Threshold Voltage			$I_{C} = 250 \mu A, V_{CE} = V_{GE}$		3.5	5.5	7.5	V
				$I_{\rm C} = 40$ A, $V_{\rm GE} = 15$ V			2.6	3.2	V
Vor(+)		collector to Emitter aturation Voltage		I _C = 40A, V _{GE} = 15V, T _C = 125°C			2.9		V
		_	0	V _{GE} = 15V		3.15		V	
Dynamic Cr C _{ies} C _{oes}	haracteristics Input Capacitance Output Capacitance			V _{CE} = 30V, V _{GE} = 0V			3200 370		pF pF
C _{res}	•	Transfer Capacitance		f = 1MHz			125		pF
Switching C									
t _{d(on)}	Turn-On	Delay Time					15		ns
t _r	Rise Time			$V_{CC} = 600V, I_C = 40A,$ $R_G = 5\Omega, V_{GE} = 15V,$			20		ns
t _{d(off)}	Turn-Off	Turn-Off Delay Time Fall Time					110		ns
t _f	Fall Time						40	80	ns
E _{on}	Turn-On	Switching Loss		Inductive Load, T _C = 25°C			2.3	3.45	mJ
E _{off}		Switching Loss					1.1	1.65	mJ
E _{ts}		ritching Loss					3.4	5.1	mJ
t _{d(on)}		Delay Time		$V_{CC} = 600V, I_C = 40A,$ $R_G = 5\Omega, V_{GE} = 15V,$ Inductive Load, $T_C = 125^{\circ}C$			20		ns
t _r	Rise Tim						25		ns
t _{d(off)}		Delay Time	,				120		ns
t _f	Fall Time						45		ns
E _{on}		Switching Loss					2.5		mJ
E _{off}		Switching Loss					1.8		mJ
E _{ts}		vitching Loss					4.3		mJ
Q _g		te charge		V _{CE} = 600	V, I _C = 40A.		220	330	nC
Q _{ge}		nitter Charge					25	38	nC nC
Q _{gc}		ellector Charge		V _{CE} = 600V, I _C = 40A, V _{GE} = 15V			130	195	+

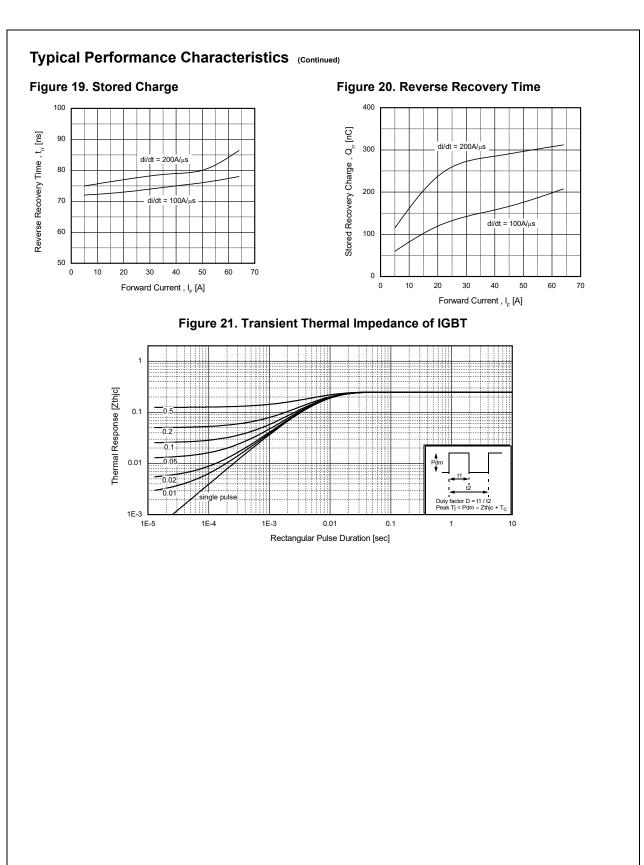
Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Units
V _{FM}	Diode Forward Voltage	I _F = 40A	T _C = 25°C		3.2	4.0	v
			T _C = 125°C		2.7		
t _{rr}	Diode Reverse Recovery Time	I _F = 40A, di/dt = 200A/μs	T _C = 25°C		75	112	nS
			T _C = 125°C		130		
I _{rr}	Diode Peak Reverse Recovery Current		T _C = 25°C		8	12	A
			T _C = 125°C		13		
Q _{rr}	Diode Reverse Recovery Charge		T _C = 25°C		300	450	nC
			T _C = 125°C		845		

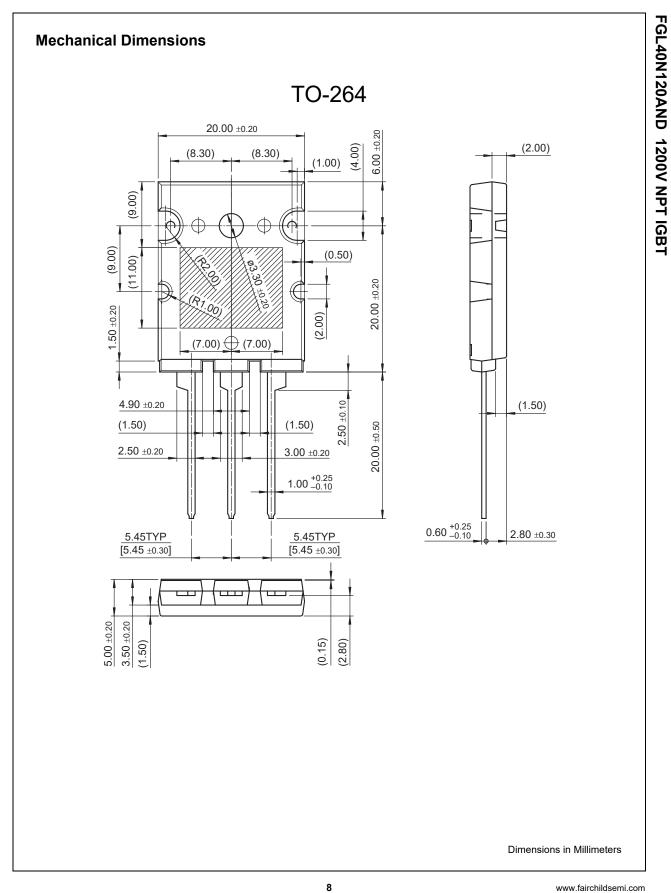














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